

MOSFET

OptiMOS[™] 5 Power-Transistor, 60 V

Features

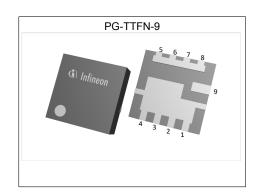
- Optimized for high performance SMPS, e.g. synchronous rectification
- N-channel, logic level
 Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

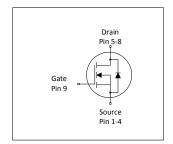


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Kev Performance Parameters**

Parameter	Value	Unit
V _{DS}	60	V
R _{DS(on),max} @10V	2.2	mΩ
R _{DS(on),max} @4.5V	2.9	mΩ
I_{D}	151	A
Q _{oss}	45	nC
Q _G (0V4.5V)	26	nC











Type / Ordering Code	Package	Marking	Related Links
IQE022N06LM5CG	PG-TTFN-9	022N6C5	-

OptiMOS[™] 5 Power-Transistor, 60 V



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OptiMOS[™] 5 Power-Transistor, 60 V IQE022N06LM5CG



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Dougueston	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	151 107 93 24	A	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =4.5 V, T _C =100 °C V _{GS} =10V, T _A =25 °C, R _{thJA} =60 °C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	604	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	241	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	100 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²)
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	0.9	1.5	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 60 V IQE022N06LM5CG



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

D	0		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.1	1.7	2.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=48\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μΑ	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	1.9 2.5	2.2 2.9	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =10 A
Gate resistance	R _G	-	1.1	1.4	Ω	-
Transconductance ¹⁾	g fs	-	93	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 Dynamic characteristics

Devementar	Comphal	Values			11:4	Nata (Tast Osmalitisas
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	3400	4420	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	720	936	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	35	63	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	6.1	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	4.1	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	26	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	5.9	_	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Ob. a.l.	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	8.5	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	5.9	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	8	12	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q_{sw}	-	10.7	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	26	33	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.5	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total	Qg	-	53	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Output charge ¹⁾	Qoss	-	45	59	nC	V _{DS} =30 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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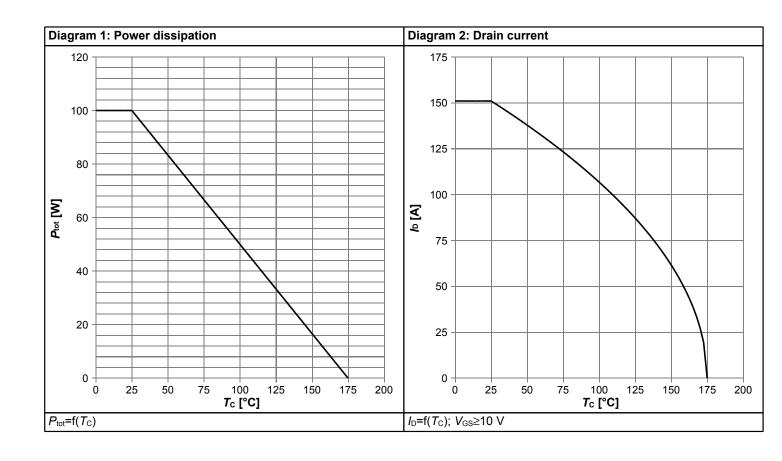


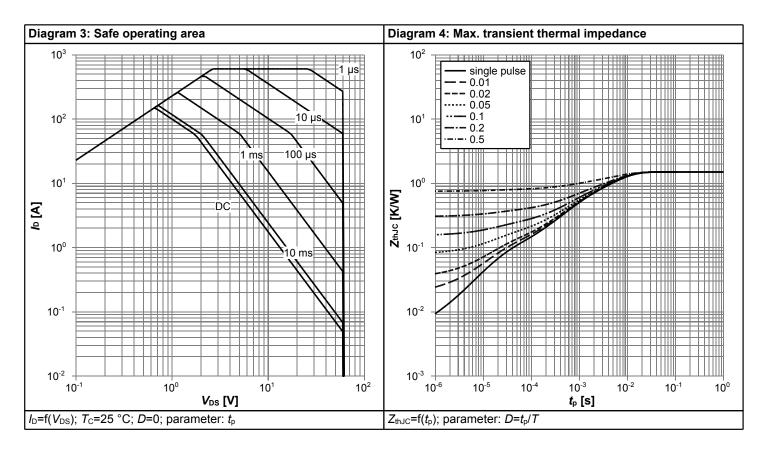
Table 7 Reverse diode

Davamatav	Comple el		Values			Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	91	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	604	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.79	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	26	52	ns	V _R =30 V, I _F =20 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	19	38	nC	V _R =30 V, I _F =20 A, di _F /dt=100 A/μs
Reverse recovery time ¹⁾	t _{rr}	-	17	34	ns	V_R =30 V, I_F =20 A, di_F/dt =1000 A/ μ s
Reverse recovery charge ¹⁾	Qrr	-	98	196	nC	V _R =30 V, I _F =20 A, di _F /dt=1000 A/µs

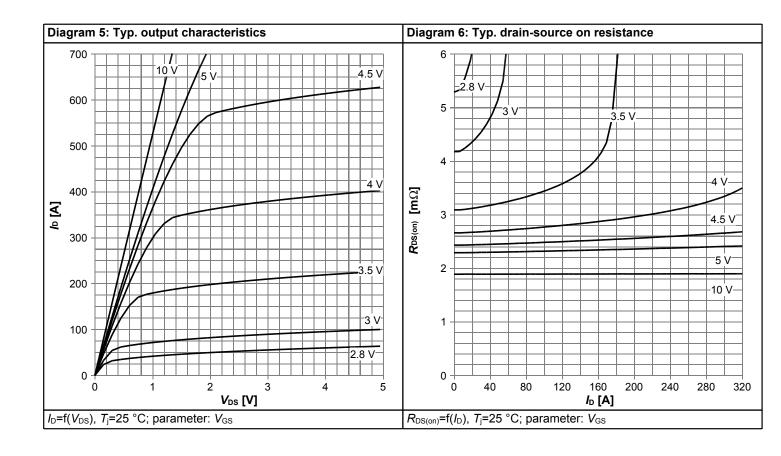


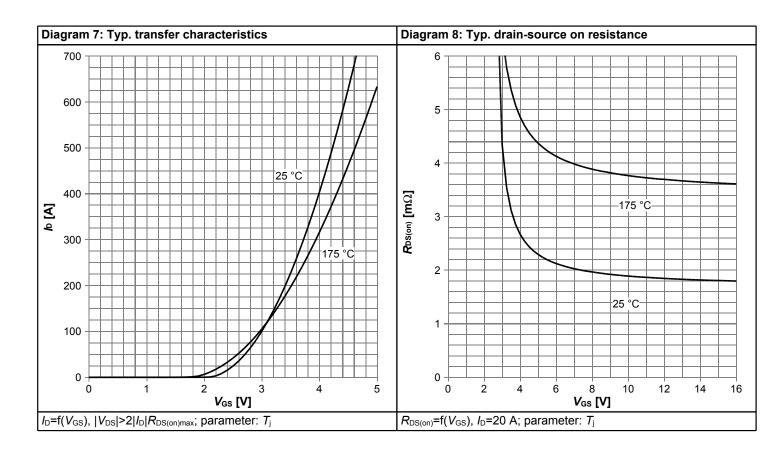
4 Electrical characteristics diagrams



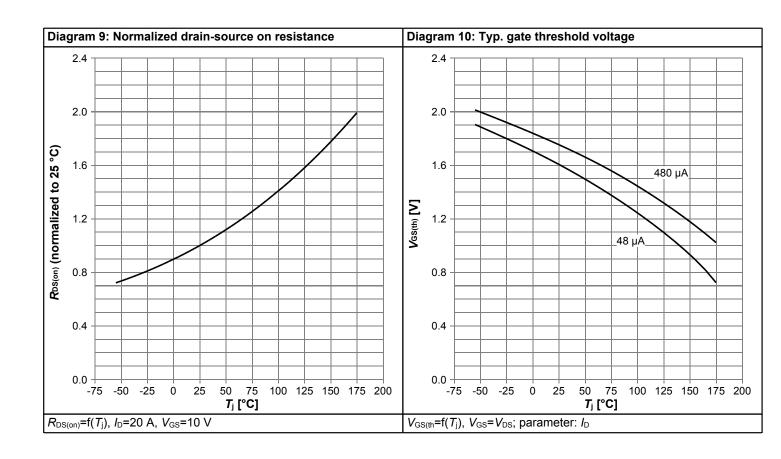


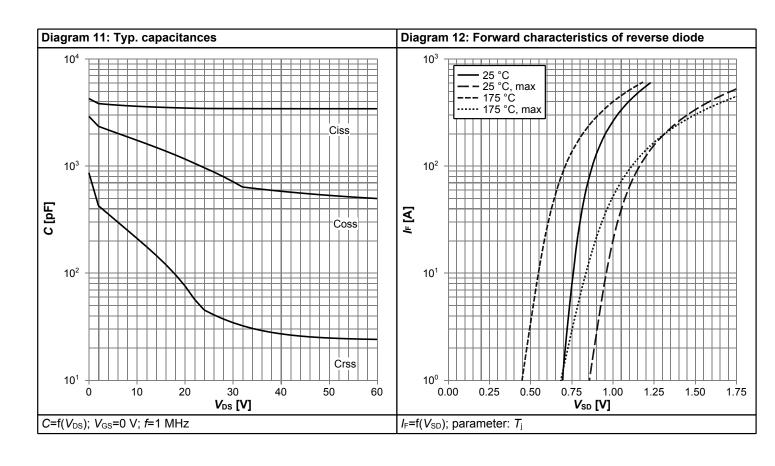




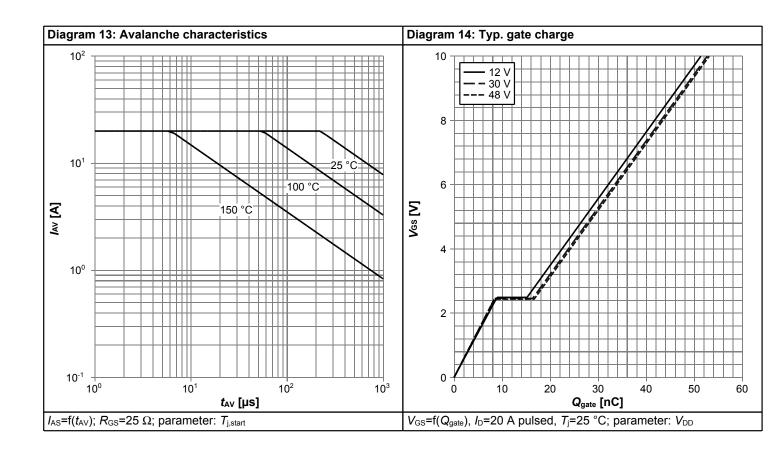


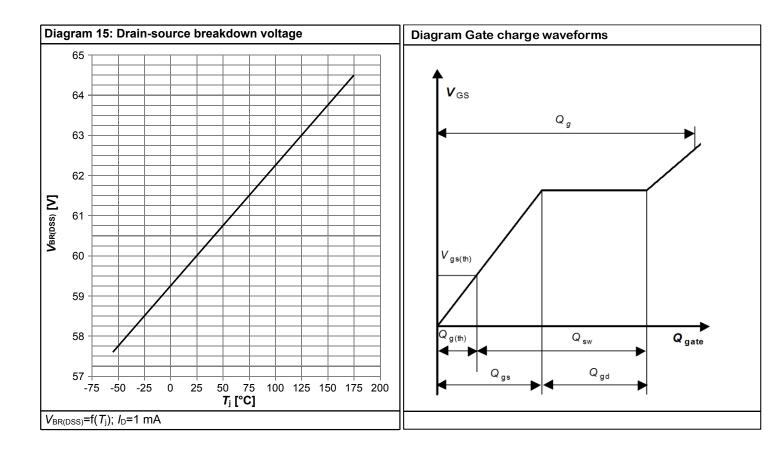






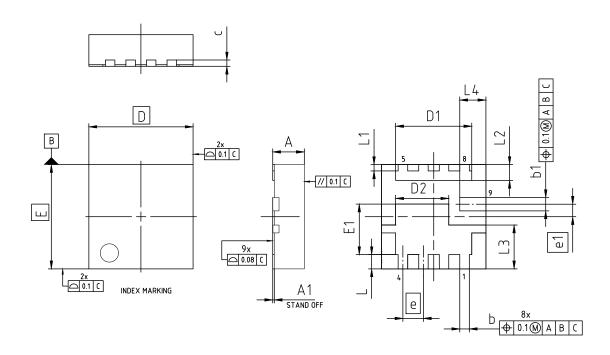








5 Package Outlines



DIMENSION	MILLIM	IETERS				
DIMENSION	MIN.	MAX.				
Α	-	1.10				
A1	-	0.05				
b	0.20	0.40				
b1	0.32	0.52				
С	0.	20				
D	3.30					
D1	2.31	2.51				
D2	1.58	1.78				
E	3.30					
E1	1.50	1.70				
е	0.65					
e1	0.395					
L	0.35	0.55				
L1	0.10	0.30				
L2	0.40	0.60				
L3	1.285	1.485				
L4	0.73	0.93				

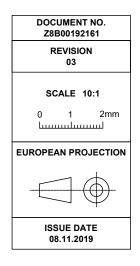


Figure 1 Outline PG-TTFN-9, dimensions in mm

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Revision History

IQE022N06LM5CG

Revision: 2023-01-12, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2023-01-12	Release of final version			

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Final Data Sheet 11 Rev. 2.0, 2023-01-12